

NEW

OMRON

High-speed automated X-ray CT inspection system

VT-X750



VT-X750

In-line Full Inspection System

Best quality @ min. Q-cost



VT-X750

Best Quality at the Minimum Q-cost.



Productivity
Capability
Safety
Security

Innovation to maximize ROI.

P Productivity

In-line full inspection coverage

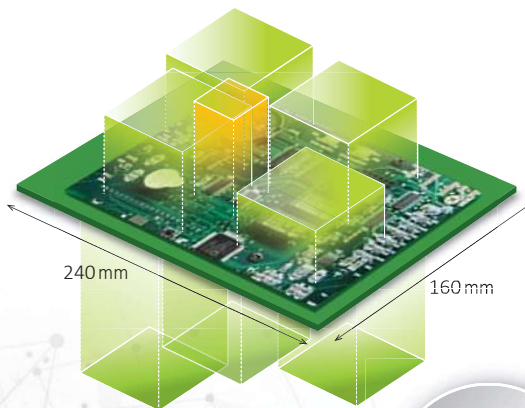
The VT-X750 improves upon previous Omron 3D-CT technology making it the fastest X-Ray inspection system to date *1. The automated inspection logic has been improved for many parts such as IC heel fillets, stacked devices (PoP), through hole components, press-fit connectors, and other bottom terminated parts. Increasing automated inspection speed and expanding inspection logic enables full, in-line inspection coverage by 3D-CT method.

*1. By an internal investigation in October, 2020.

8 FOV's

Components

BGA × 2
LGA × 2
QFP × 4
Connector × 2
Chip, etc. × 1,500



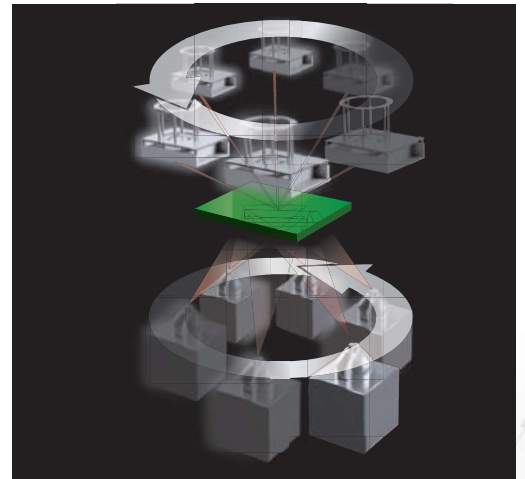
Inspection speed

VT-X700 70.9 seconds ▶ VT-X750 34.8 seconds *

* Exclude load and unload

Inspection speed

2 times
or more



C Capability

Visualize solder joint strength

OMRON's unique 3D-CT reconstruction algorithms provide excellent solder shape recognition and defect detection.

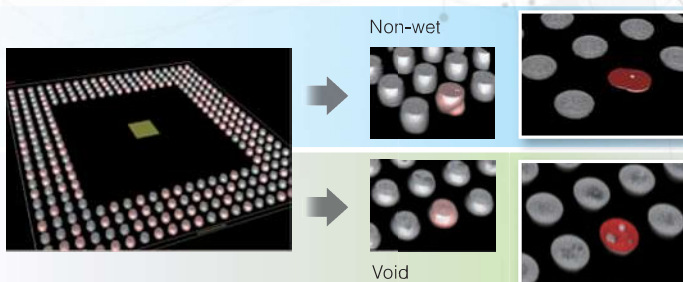
Quantitative analysis allows for an automated inspection process which minimizes the risk of escapes while providing fast and repeatable operation.

Design constraint free

Dense and dual sided board design can provide challenges for X-Ray inspection.

However, Omron's 3D-CT technology can overcome such design restraints.

Visualize solder joint strength



BGA, 3D rendering image

AI Dynamic Approach using Omron AI

Criteria setting by Auto-Judge reduces **Patent Pending** the dependency on a dedicated programmer

This dynamic approach enables a comprehensive analysis using **Omron AI** with quantitative decision making based on conventional inspection standards for OK / NG judgment. (3D cross-sectional display functionality has been integrated into the screen, making the inspection criteria settings easier to understand.)

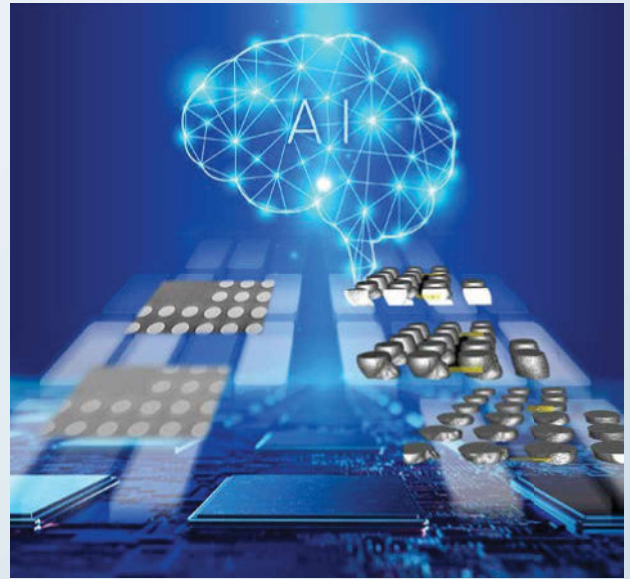
Faster creation of new programs **Omron Patent**

Omron AI assists in the quick creation of new programs. Along with automated program generation using CAD data, **Omron AI** automatically tunes the parts library using inspection result data.

Accelerated simulation for production preparation **Patent Pending**

Omron AI simulates the optimum tact and exposure dosage for each part and automatically determines the corresponding conditions for the X-ray inspection process.

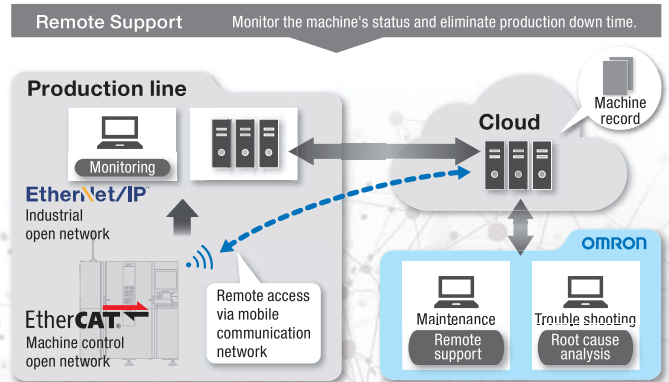
* Simulation pertains to specific parts.



S Security

🕒 Zero down time

To achieve “Zero down time” during the SMT production process, OMRON supports machine operation globally by preventative maintenance, emergency support and machine monitor with remote access.



S Safety

☢️ Reduce radiation exposure

• High speed imaging technology

The VT-X750 provides the shortest X-ray exposure time without sacrificing inspection image quality.

• X-ray source at the bottom

By locating the X-ray source under the board, both exposure and dosage is physically reduced to the more important devices mounted on the top.

• Low energy-cut filter

Standard equipped filter reduces X-ray exposure further minimizing damage concerns to memory products.

👤 Operation safety

• Ultratrace leakage dose

Exposure dosage to operator is less than 0.18 mSv *2 per a year. This is less than one-tenth compared with that from natural environment.

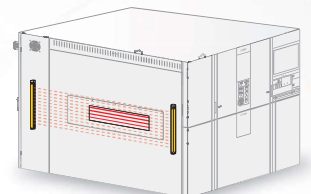
*2. Teaching operation for one hour per day. $0.5\mu\text{Sv/h} \times 1\text{h/day} \times 365\text{days} = 0.183\text{mSv}$

• OMRON's safety components

The VT-X750 complies with CE, SEMI S2/S8 and other safety standards by utilizing OMRON's latest generation of safety controller and light curtain products.

• X-ray shielding box, made in Japan

The machine shielding quality is ensured through three surveys (twice at the factory in Japan and once on site).



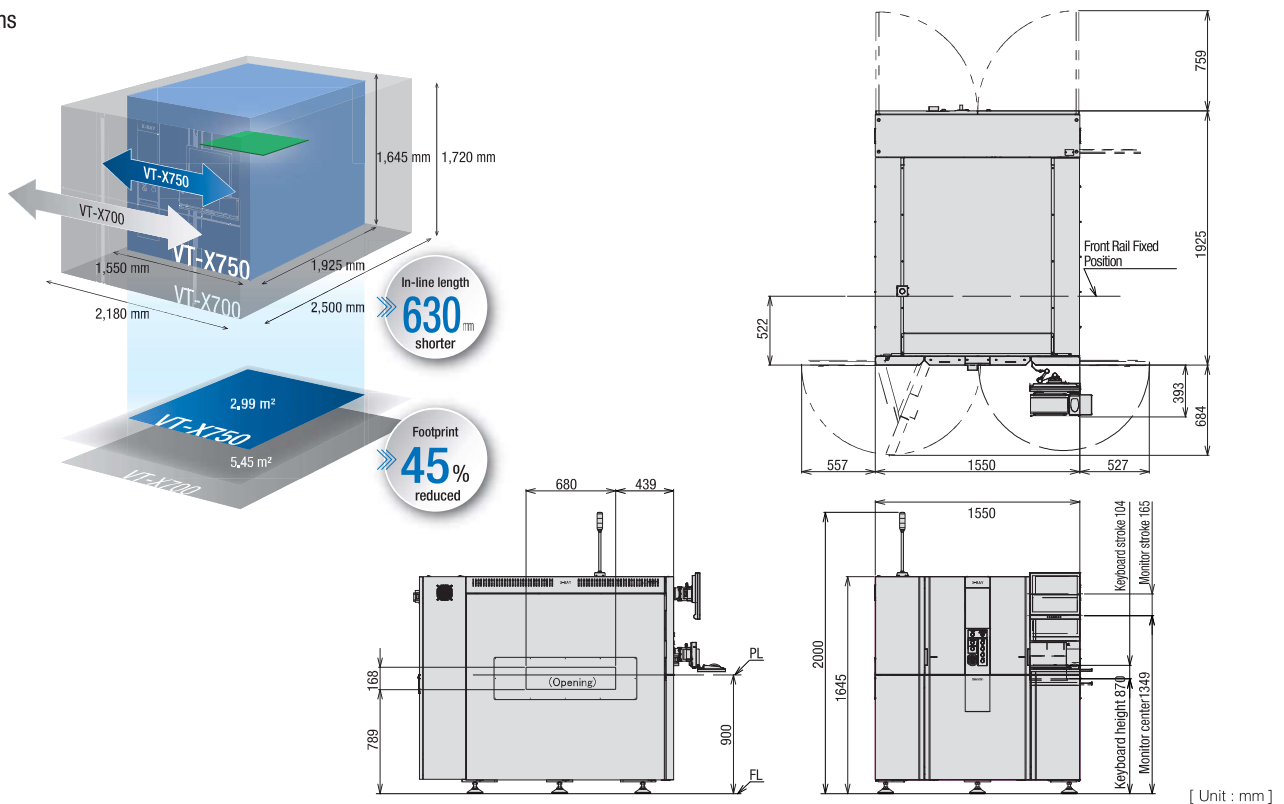
Specifications

■ Hardware configuration / Function

| Item | | Description | | |
|-------------------|---------------------|--|---|--|
| Model | | VT-X750 | | VT-X750-XL |
| Type | | H-FR | FR | H-FR |
| Inspection object | | BGA/CSP, inserted components, SOP, QFP, transistors, R/C chips, bottom-side terminal components, QFN, Power devices, POP, Press-fit CN, etc. | | |
| Inspection items | | Void, open, non-wet, Solder Volume, shifting, foreign object, bridging, Solder fillet, TH Solder filling, Solder ball, etc. (selectable to applications) | | |
| Imaging system | Method | 3D-slice imaging by using parallel CT | | |
| | Resolution | 6, 8, 10, 15, 20, 25, 30 μm/pixel (selectable in the inspection program) | 3, 6, 8, 10, 15, 20, 25, 30 μm/pixel (selectable in the inspection program) | 10, 15, 20, 25, 30 μm/pixel (selectable in the inspection program) |
| | X-ray source | Micro-focus closed tube | | |
| | X-ray detector | Flat panel detector | | |
| PCBA | Size | 50x50~610x515mm (2x2 to 24x20 inch), Thickness: 0.4~5.0mm (0.4~3.0mm in 3 μm resolution) | | 100x50~1200x610mm, Thickness: 0.4~15.0mm |
| | Weight | Less than 4.0 kg (with component mounted) | | Less than 15kg |
| | Component clearance | Top: Less than 40 mm, Bottom: less than 39 mm | | Top: Less than 40 mm, Bottom: Less than 40 mm |
| | Warpage | Less than 2.0 mm (Less than 1.0mm in 3 μm resolution) | | Less than 3.0 mm |
| | Footprint | 1,550(W) x 1,925(D) x 1,645(H) mm | | 2,180(W) x 2,510(D) x 1,735(H)mm |
| Main body | Weight | Approx. 3,100kg | | Approx. 5,350kg |
| | Conveyor height | 900 ± 20 mm | | |
| | Power supply | Single phase, 200 to 240 VAC, 50/60 Hz | | |
| | Rated power | 2.4kVA | | 2.58kVA |
| | X-ray leakage | Less than 0.5 μSv/h | | |
| | Air supply | 0.4 to 0.6 Mpa | | |
| | Safety standard | CE, SEMI, NFPA, FDA | | CE, SEMI, NFPA, FDA *Under Acquiring |

Dimensions

■ VT-X750



EtherNet / IP™ is the trademark of ODVA.

EtherCAT® is registered trademark and patented technology, licensed by Beckhoff Automation GmbH, Germany.

- This document provides information mainly for selecting suitable models. Please read the Instruction Sheet carefully for information that the user must understand and accept before purchase, including information on warranty, limitations of liability, and precautions.
- This product may cause interference if used in residential areas.

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